



FDH50N50_F133 / FDA50N50

500V N-Channel MOSFET

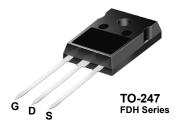
Features

- 48A, 500V, $R_{DS(on)} = 0.105\Omega$ @ $V_{GS} = 10 V$
- Low gate charge (typical 105 nC)
- Low C_{rss} (typical 45 pF)
- · Fast switching
- 100% avalanche tested
- · Improved dv/dt capability

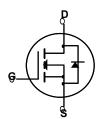
Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switched mode power supplies and active power factor correction.







Absolute Maximum Ratings

Symbol	Parameter		FDH50N50_F133/FDA50N50	Unit	
V _{DSS}	Drain-Source Voltage			500	V
I _D		- Continuous ($T_C = 25$ °C) - Continuous ($T_C = 100$ °C)		48 30.8	A A
I _{DM}	Drain Current	- Pulsed	(Note 1)	192	Α
V _{GSS}	Gate-Source voltage		±20	V	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	1868	mJ
I _{AR}	Avalanche Current		(Note 1)	48	Α
E _{AR}	Repetitive Avalanche Energy		(Note 1)	62.5	mJ
dv/dt	Peak Diode Recovery	dv/dt	(Note 3)	4.5	V/ns
P_D	Power Dissipation (T _C = 25°C) - Derate above 25°C		625 5	W W/°C	
T _{J,} T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
T _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds		300	°C	

Thermal Characteristics

Symbol	Parameter	Min.	Max.	Unit	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.2	°C/W	
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.24		°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		40	°C/W	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDH50N50_F133	FDH50N50_F133	TO-247	-	-	30
FDA50N50	FDA50N50	TO-3P	-	-	30

Electrical Characteristics $T_C = 25$ °C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Тур.	Max	Units
Off Charac	Off Characteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	500			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250μA, Referenced to 25°C		0.5		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 500V, V _{GS} = 0V V _{DS} = 400V, T _C = 125°C			25 250	μ Α μ Α
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 20V, V _{DS} = 0V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -20V, V _{DS} = 0V			-100	nA
On Charac	teristics		I.	I.		'
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10V, I _D = 24A		0.089	0.105	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 40V, I _D = 48A (Note 4)		20		S
Dynamic C	Characteristics		I.	I.		'
C _{iss}	Input Capacitance $V_{DS} = 25V, V_{GS} = 0V,$			4979	6460	pF
C _{oss}	Output Capacitance	f = 1.0MHz		760	1000	pF
C _{rss}	Reverse Transfer Capacitance			50	65	pF
C _{oss}	Output Capacitance	V _{DS} = 400V, V _{GS} = 0V, f = 1.0MHz		161		pF
Coss eff.	Effective Output Capacitance	V _{DS} = 0V to 400V, V _{GS} = 0V		342		pF
Switching	Characteristics		•			
t _{d(on)}	Turn-On Delay Time	V _{DD} = 250V, I _D = 48A		105	220	ns
t _r	Turn-On Rise Time	$R_G = 25\Omega$		360	730	ns
t _{d(off)}	Turn-Off Delay Time			225	460	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		230	470	ns
Qg	Total Gate Charge	V _{DS} = 400V, I _D = 48A		105	137	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10V		33		nC
Q_{gd}	Gate-Drain Charge	(Note 4, 5)		45		nC
Drain-Sour	rce Diode Characteristics and Maximur	n Ratings	l	I		ı
I _S	Maximum Continuous Drain-Source Diode Forward Current				48	Α
I _{SM} Maximum Pulsed Drain-Source Diode Fo		orward Current			192	Α
V_{SD}	Drain-Source Diode Forward Voltage	Voltage $V_{GS} = 0V$, $I_S = 48A$			1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, I _S = 48A		580		ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$ (Note 4)		10		μС

NOTES:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L = 1.46mH, I $_{AS}$ = 48A, V $_{DD}$ = 50V, R $_{G}$ = 25 Ω , Starting T $_{J}$ = 25°C
- 3. $I_{SD} \leq$ 48A, di/dt \leq 200A/ μ s, $V_{DD} \leq$ BV $_{DSS}$, Starting T $_{J}$ = 25°C
- 4. Pulse Test: Pulse width $\leq 300 \mu s,$ Duty Cycle $\leq 2\%$
- 5. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

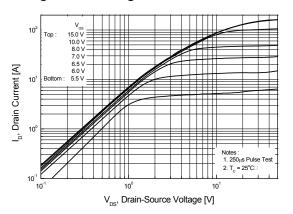


Figure 2. Transfer Characteristics

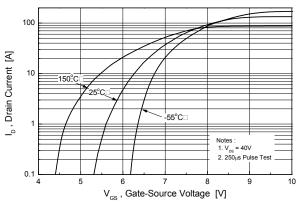


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

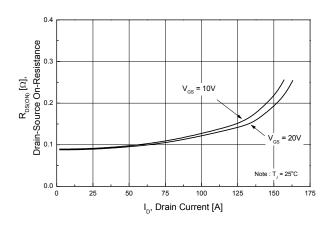


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperatue

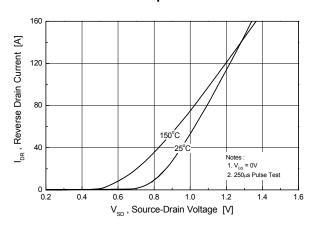


Figure 5. Capacitance Characteristics

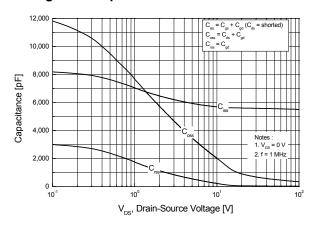
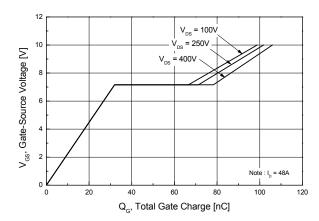


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

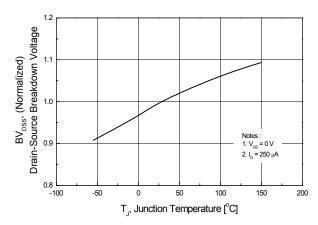


Figure 8. On-Resistance Variation vs. Temperature

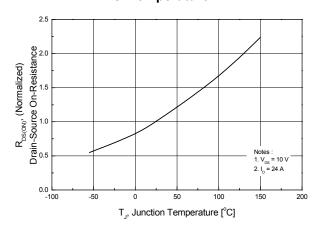


Figure 9. Maximum Safe Operating Area

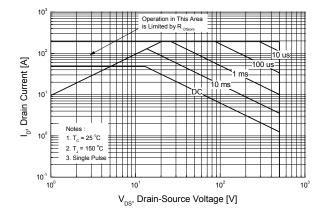


Figure 10. Maximum Drain Current vs. Case Temperature

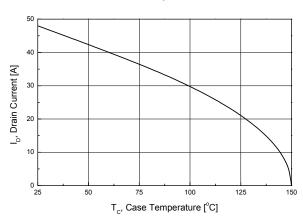


Figure 11. Typical Drain Current Slope vs. Gate Resistance

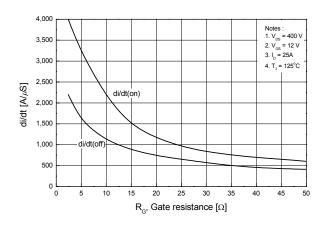
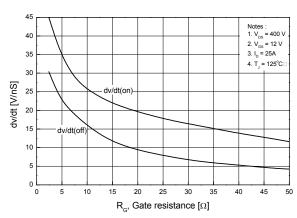


Figure 12. Typical Drain-Source Voltage Slope vs. Gate Resistance



Typical Performance Characteristics (Continued)

Figure 13. Typical Switching Losses vs. Gate Resistance

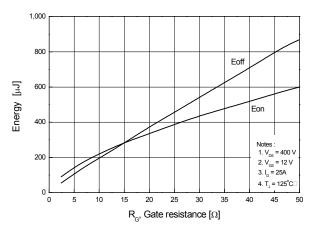


Figure 14. Unclamped Inductive Switching Capability

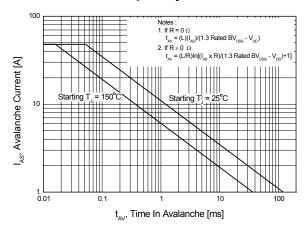
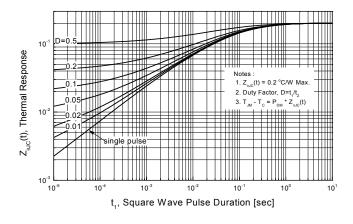
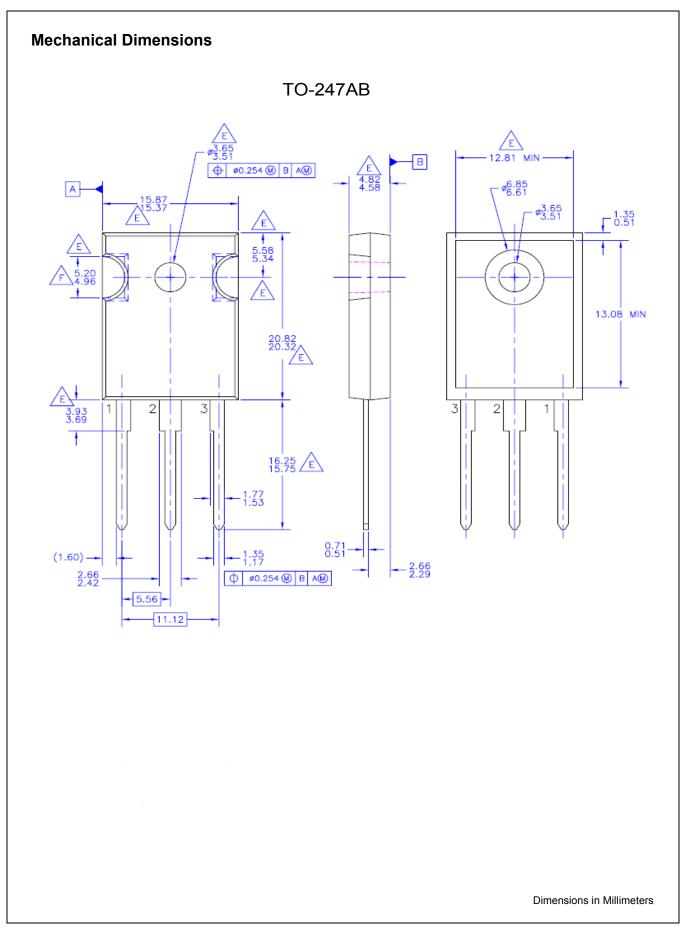


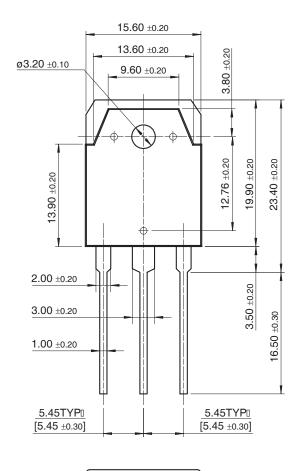
Figure 15. Transient Thermal Resistance Curve

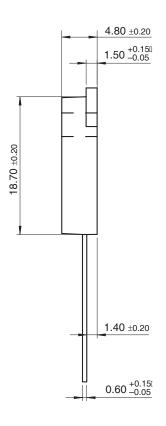




Mechanical Dimensions (Continued)

TO-3P





Dimensions in Millimeters





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

Build it Now™
CorePLUS™
CorePOWER™
CROSSVOLT™
CTL™

Current Transfer Logic™ EcoSPARK[®] EfficentMax™ EZSWITCH™ *

₽ ₽ Reirchild®

Fairchild Semiconductor[®] FACT Quiet Series™

FACT Quiet Series™
FACT®
FAST®
FastvCore™
FlashWriter® *
FPS™
F-PFS™

FRFET[®]
Global Power ResourceSM
Green FPS™

Green FPS™ e-Series™

GTO™
IntelliMAX™
ISOPLANAR™
MegaBuck™
MICROCOUPLER™
MicroFET™

MicroFET™ MicroPak™ MillerDrive™ MotionMax™ Motion-SPM™ OPTOLOGIC® OPTOPLANAR®

PDP SPM™
Power-SPM™
PowerTrench®
PowerXS™

Programmable Active Droop™
OFFT®

QFET[®]
QS™
Quiet Series™
RapidConfigure™

Saving our world, 1mW /W /kW at a time™ SmartMax™ SMART START™

SPM®
STEALTH™
SuperFET™
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8
SupreMOS™
SyncFET™
®

SYSTEM ®
GENERAL
The Power Franchise®

franchise
TinyBoost™
TinyBuck™
TinyLogic®
TINYOPTO™
TinyPower™
TinyPower™
TinyWire™
μSerDes™

SerDes*
UHC'®
Ultra FRFET™
UniFET™
VCX™
VisualMax™
XS™

* EZSWITCH™ and FlashWriter® are trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; REITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN. WHICH COVERS THESE PRODUCTS.

IFE SUPPORT POLICY

LIFE SUPPORT FOLICT
FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are
 intended for surgical implant into the body or (b) support or sustain life,
 and (c) whose failure to perform when properly used in accordance with
 instructions for use provided in the labeling, can be reasonably
 expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Farichild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Farichild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Farichild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Farichild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I37